

# ND-LAr (ArgonCube) Consortium: Technical Overview

Dan Dwyer

Consortium General Meeting

3 Sep. 2020

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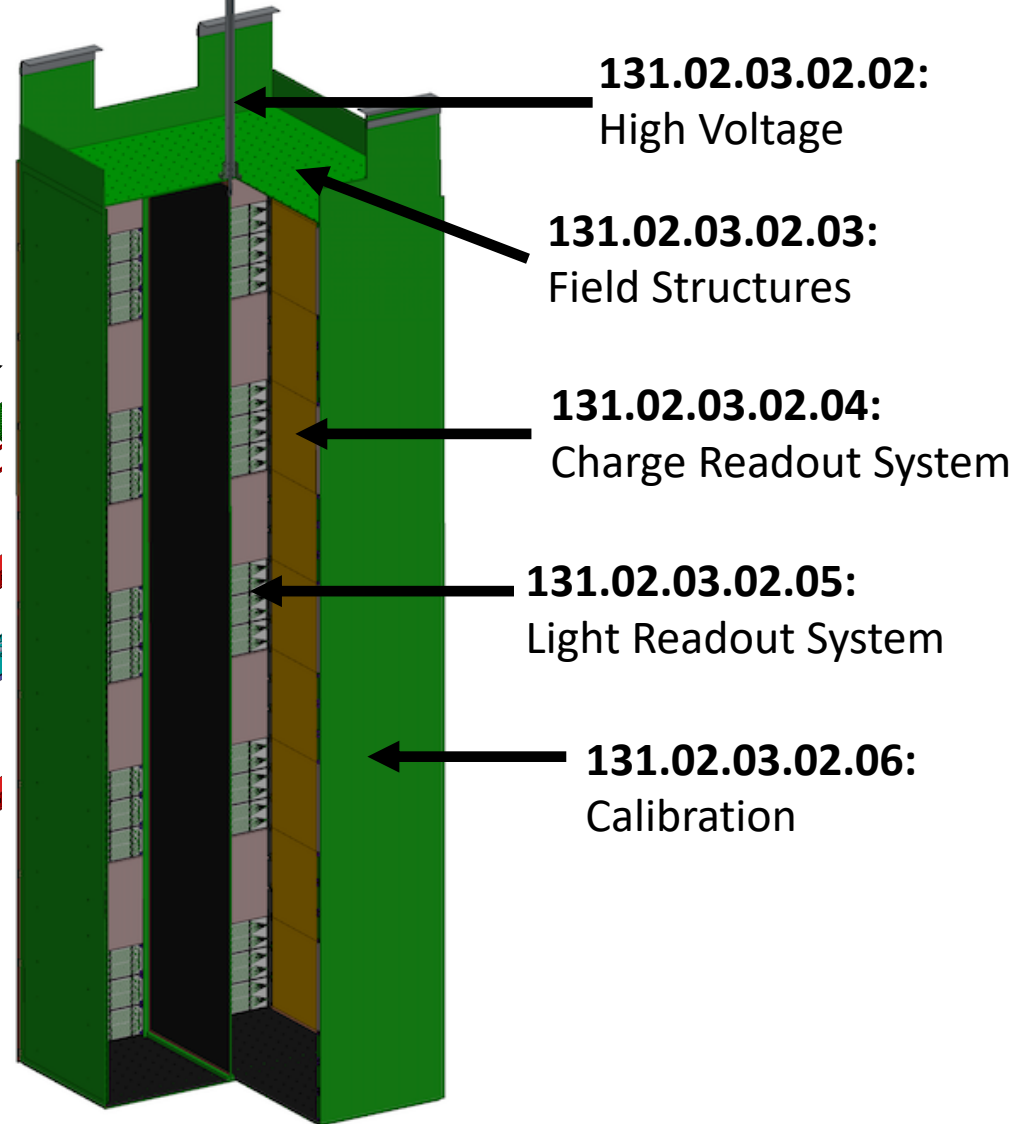
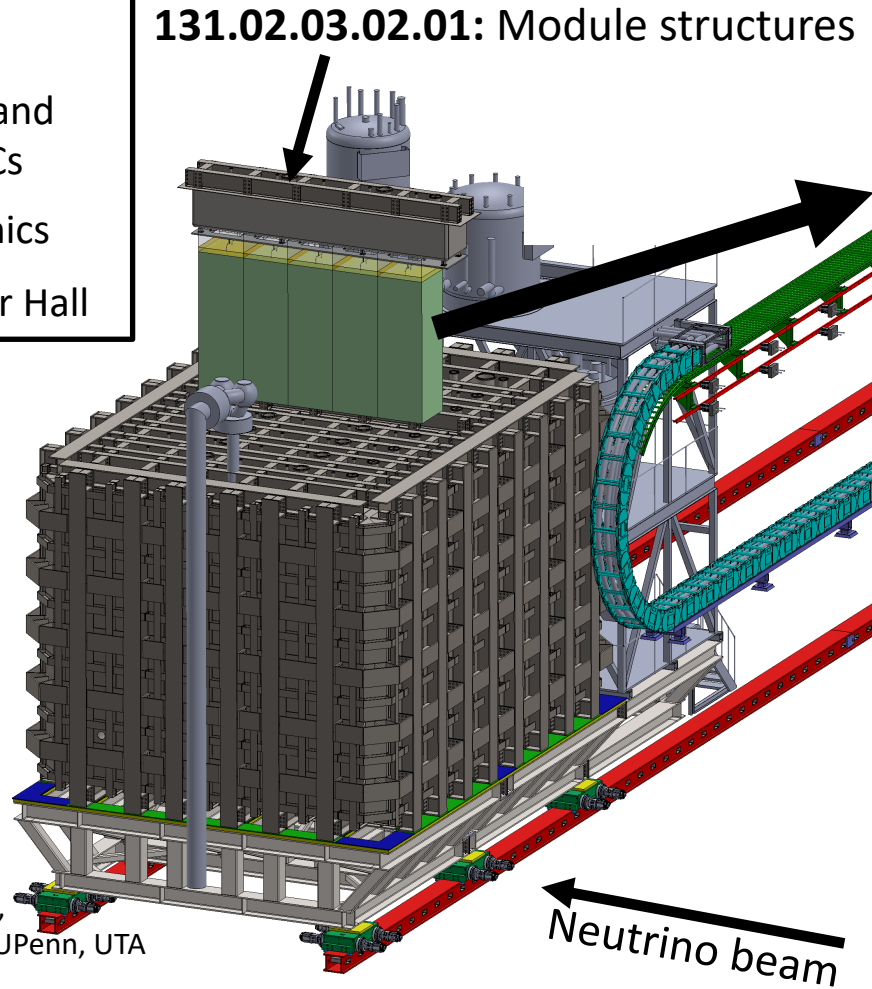
## Requirements and Specifications

- **ND-O0: Predict the observed spectrum of neutrino interactions at FD**
  - **ND-M1: ‘The ND must have a LArTPC with reconstruction capabilities comparable/exceeding the far detector’**
    - ND-T1.2: ND LArTPC Active Size: Large enough to fully contain relevant signals 3 m tall x 7 m wide x 5 m in-beam
    - ND-T1.5.1: Electric Field strength: Match the far detector drift field > 250 V/cm (goal: 500 V/cm)
    - ND-T1.6.1: Pixel Spacing: Match the far detector spatial resolution < 4.7 mm
  - **ND-O6: ‘Operate in a high-rate environment’**
    - ND-T1.6: 3D Pixel Charge Readout: High-accuracy 3D imaging in high-rate env. -
    - ND-T1.3.3: Detector Modularity: High-accuracy charge-light signal association < 3 m<sup>3</sup>
    - ND-T1.7.1: Photon detection time resolution: High-accuracy charge-light assoc. < 20 ns

# ND-LAr Consortium Scope (131.02.03.02)

## Consortium will provide:

- Design, prototyping, production, and testing of 35 (+5) modular LArTPCs
- External HV and detector electronics
- Support during installation in Near Hall



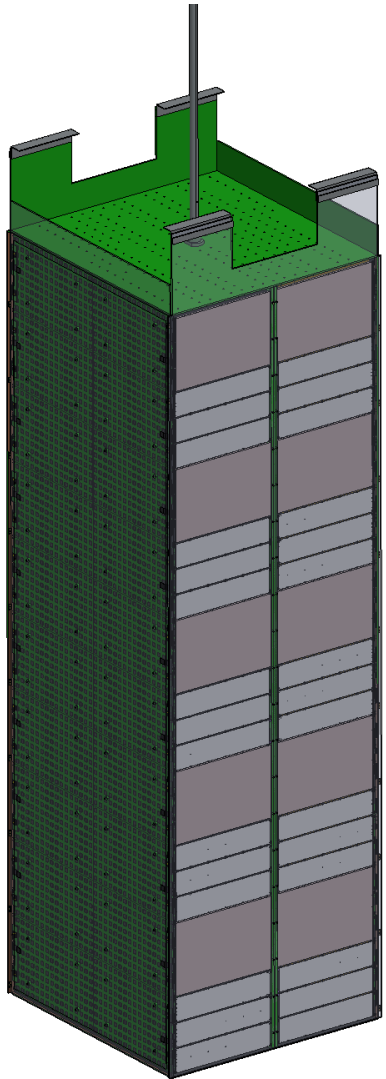
## Others:

- 131.02.03.03.07: TPC Module Integ. & Testing**
- 131.02.03.03.08: TPC Module Installation**

## Subsystem Current Institutions

Subsystem	Current Institutions
Module Structure	Univ. of Bern
HV	Univ. of Bern
Field Structure	SLAC, CSU
Charge Readout	LBLN, Caltech, CSU, Rutgers, UC-Davis, UC-Irvine, UCSB, UPenn, UTA
Light Readout	JINR, Univ. of Bern
Calibration	JINR, MSU, UH
TPC Module Integ.	All
TPC Module Install.	All

# ND LArTPC Module Design



## Modular LArTPC Design

Enables accurate signal reconstruction in high pile-up ND environment

## Module size

Each 1m x 1m x 3m module has signals from multiple neutrinos (~5) per 10us beam spill at 1.2 MW.

## Pixelated charge readout

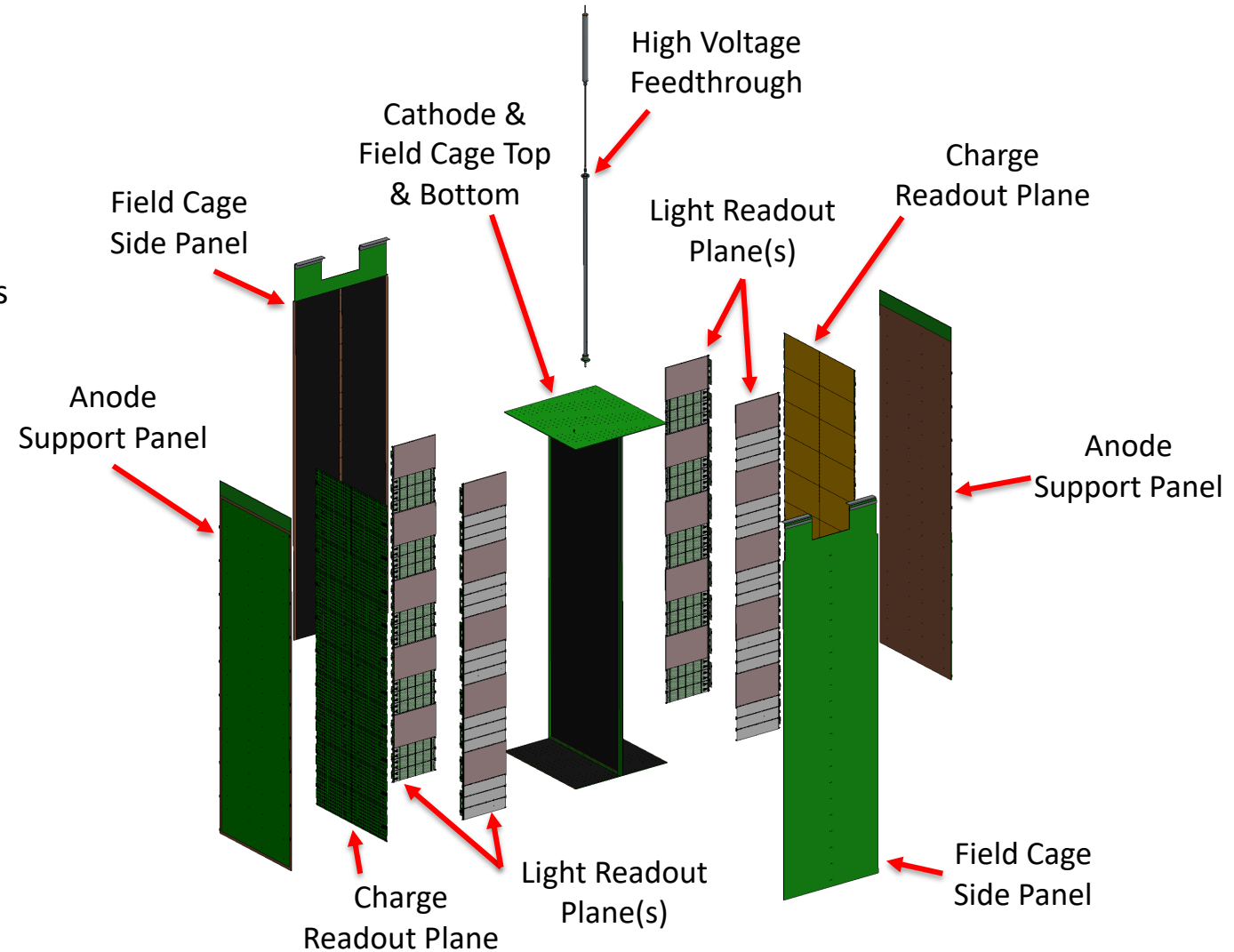
Provides true 3D imaging of ionization

## Low-profile field cage

Maximizes instrumented region  
Provides optical segmentation

## High-performance light readout

Enables accurate charge-light signal matching within each module to overcome pile-up.

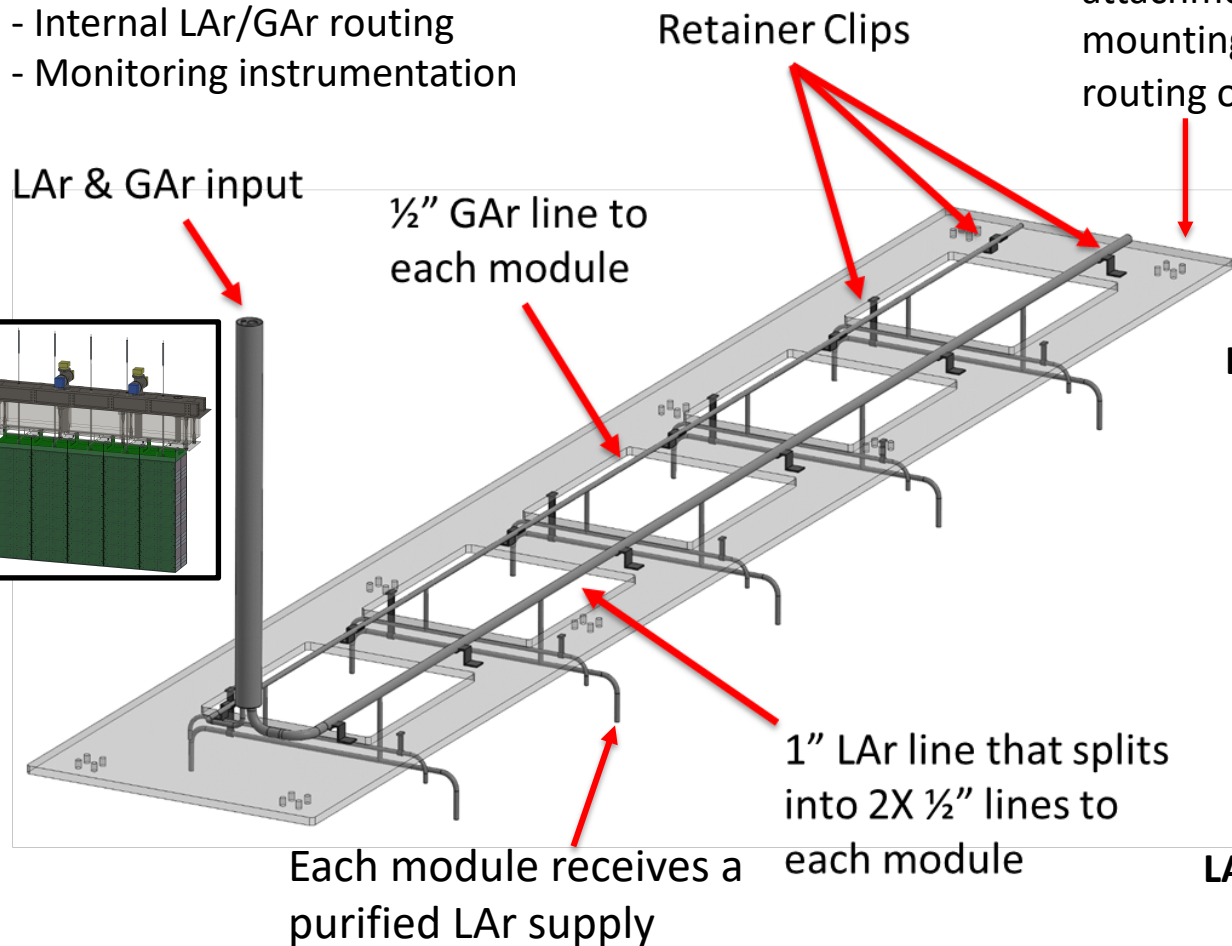
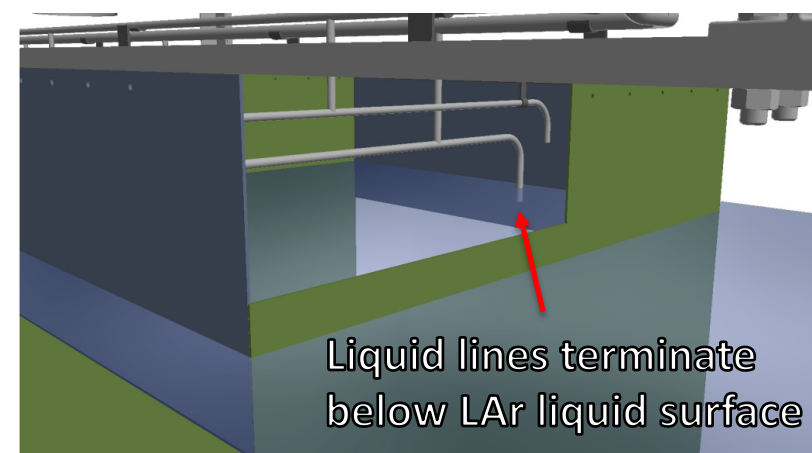


# Module Structure (131.02.03.02.01)

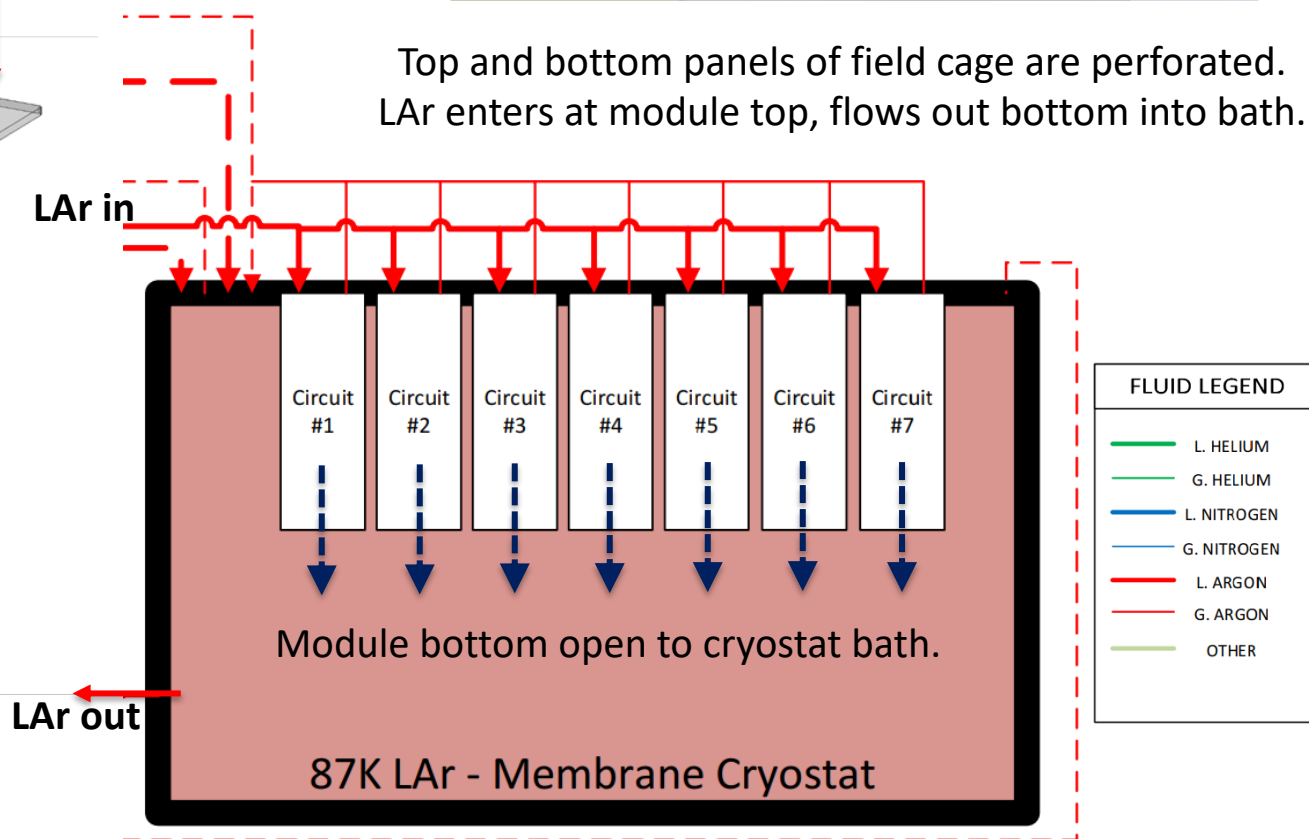
## Interfaces between detector & cryostat

- 5-module row mechanical interface plate
- Internal LAr/GAr routing
- Monitoring instrumentation

Support plate for module attachment as well for mounting clips for cryo-line routing or electronics routing



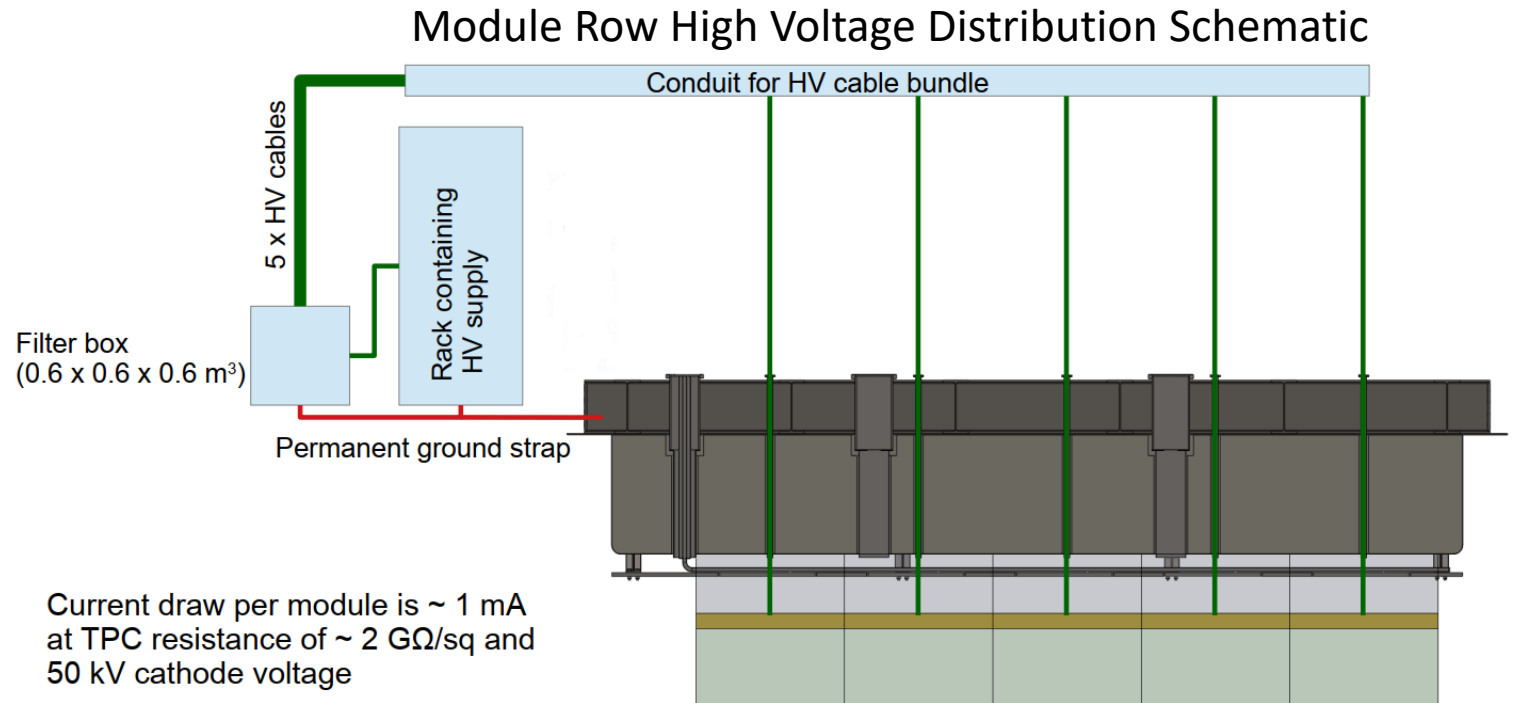
Top and bottom panels of field cage are perforated. LAr enters at module top, flows out bottom into bath.



Institutions: Univ. of Bern

# High Voltage (131.02.03.02.02)

- One power supply serves a row of 5 modules
- The power supply is connected to the modules by a single low-pass filter
- After the filter 5 resistive cables connect to the HV feedthrough/cathode
- The variations in length of the 5 cables are accounted for by adding a resistor for each cable after the filter
- For safety and to reduce ground loops, cables are bundled together in conduit until they reach their feedthrough
- The jacket of all cables (HV→filter & filter→detector) must share common ground with the filter and detector
- The detector and rack grounding must be permanent dedicated lines, regardless of ground loops



**HV Cable**

- Produced by Dielectric Sciences, INC.
- Application in nEXO
- Resistance: 8.4 kΩ/m
- Capacitance: 90 pF/m

**HV Filter**

- Low-pass filter with large capacitor & small resistor to prevent voltage drop
- Additional resistors at outlet set to match cathode voltages

**HV Supply**

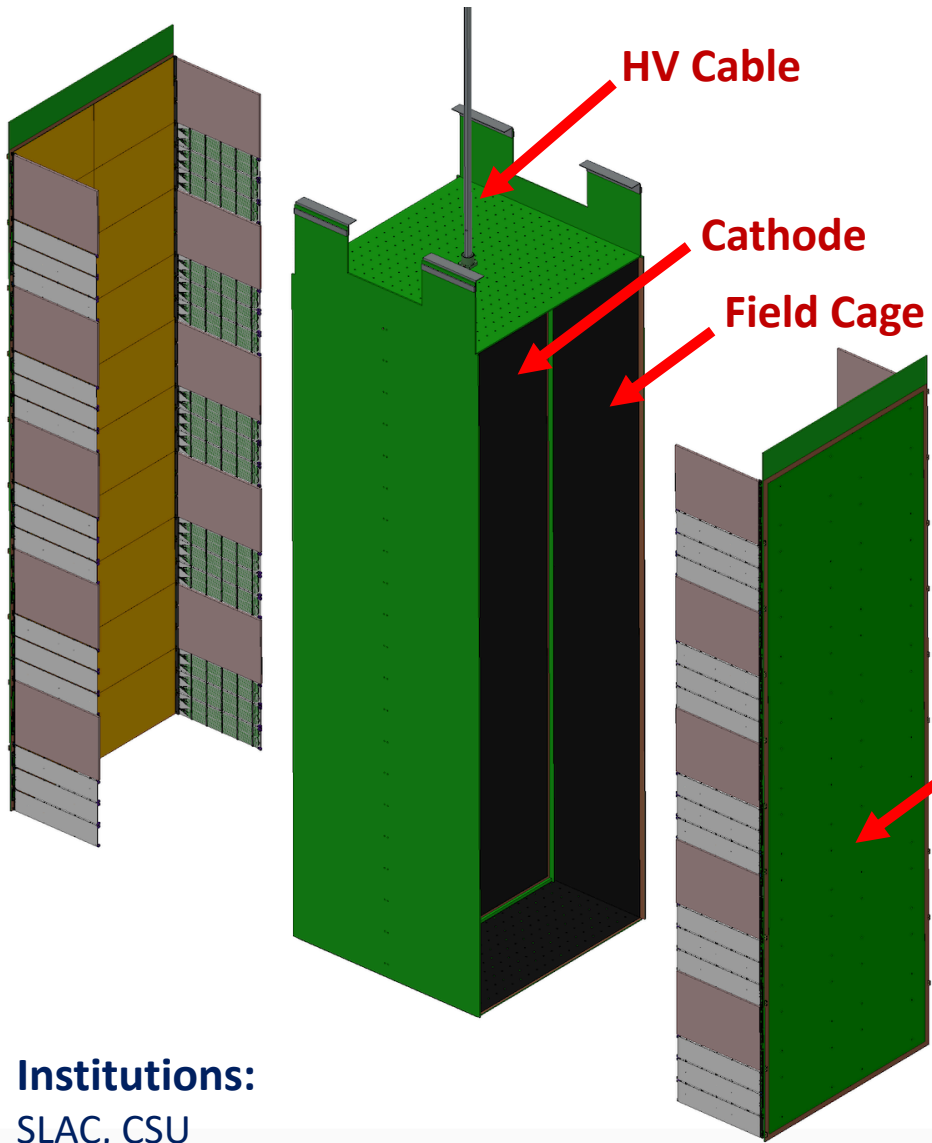
- Provide 60kV and 5 mA
- Within range of standard power supplies
- ProtoDUNE recommendation Heinzinger or Fug-Elektronik

**HV Breakdown**

- Monitor current draw
- In event of, power supply is cut
- Manual feedthrough replacement

**Institutions:** Univ. of Bern

# ND LArTPC: Field Structures (131.02.03.02.03)



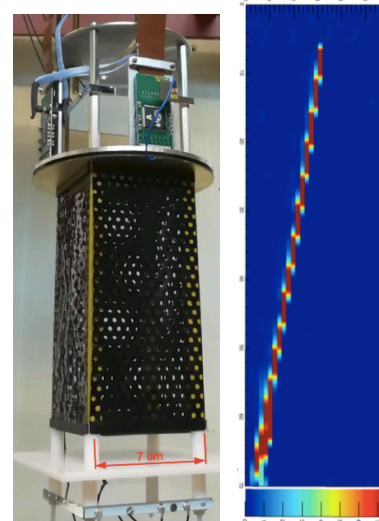
## Key Design Features:

Central cathode, dual anode with 50cm drift regions  
 → Short drift reduces required HV and associated risks

Resistive polyamide sheet laminated on G10 panels  
 → Reduces risks from accidental HV discharge  
 → No resistor chain; reduce single-point failure risk  
 → Low-profile: maximizes active volume

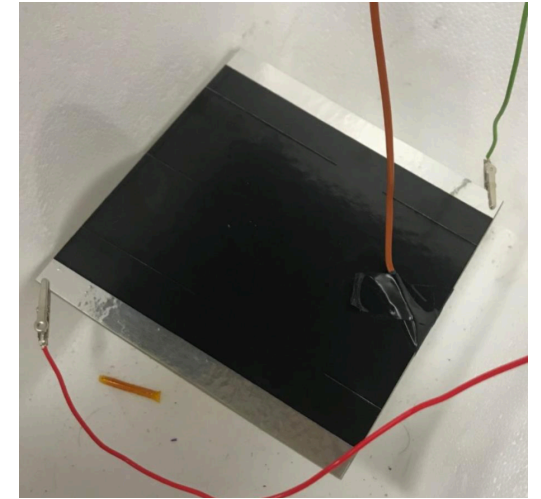
All G10 construction  
 → Similar density to LAr; reduce signal distortion  
 → Compatible thermal contraction at LAr temp

Anode Support Panel

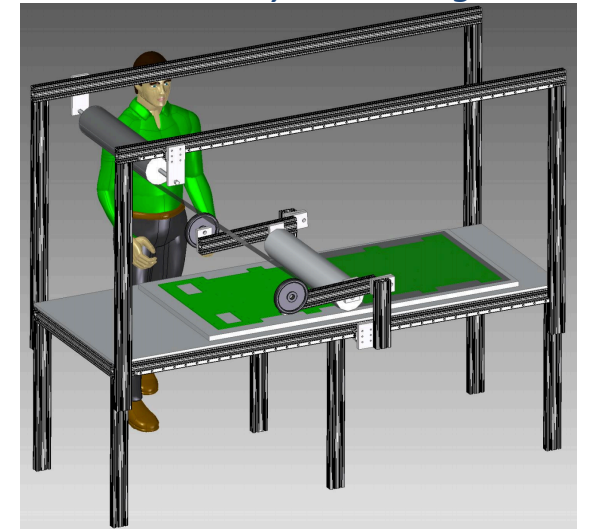


Resistive sheet LArTPC @ BERN

Cryogenic test of resistive sheet (GOhm / square) laminated on G10 panel @ SLAC



Lamination system design

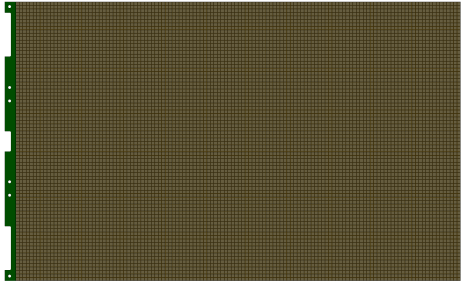


Institutions:  
 SLAC, CSU

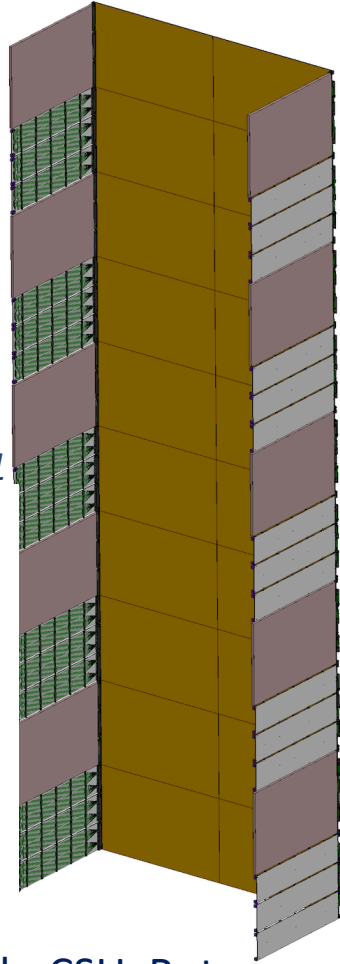
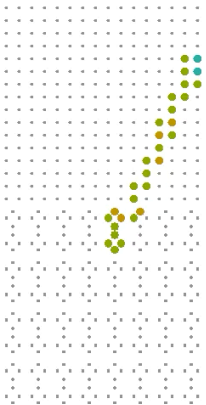
# Pixelated Charge Readout (131.02.03.02.04)

Pixelated Anode Design

ND pixel tile design,  
10,240 pixels



3D cosmic data from LArPix-v1



## Key Design Features:

- Pixelated charge readout tiles, ~4mm pitch
- True 3D imaging; no projective ambiguities
- Overcomes signal pileup at DUNE Near Site
- Mechanically robust, less sensitive to noise pickup
- Scalable design leverages commercial production

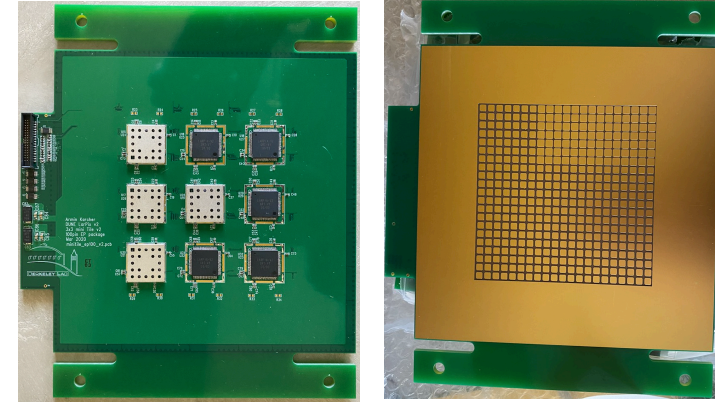
### LArPix: Custom pixel readout ASIC

- Provides low-noise, low-power, cryogenic readout
- SOC: amplification, digitization, triggering, readout
- Implements highly-scalable control, I/O architecture

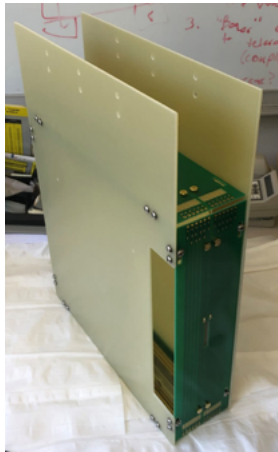
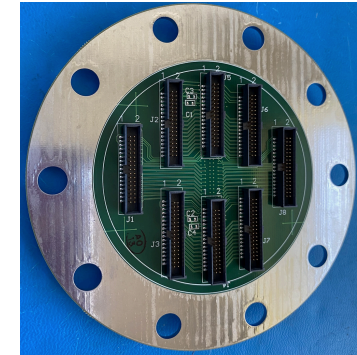
### LArPix Controller System: Pac-Man

- Leverages commercial Zynq (CPU+FPGA) system with simple custom interface PCB to control large-scale pixel system, ~1 controller per O(100k) pixel channels

'Industrialized' Pixel Tile (v2)



Pixel Tile (v2) cable feedthrough

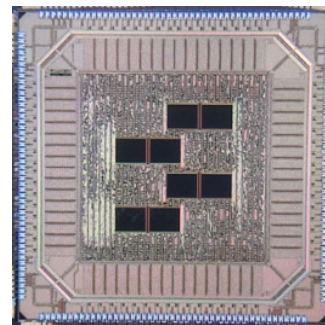


QC Test TPC  
for Pixel Tiles

LArPix-v1 ASIC



LArPix-v2 ASIC



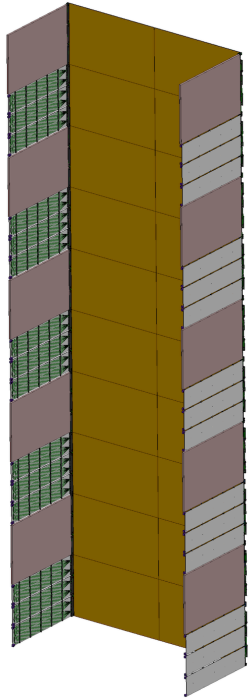
LArPix-v2 Controller



**Institutions:** LBNL, Caltech, CSU, Rutgers, UC-Davis, UC-Irvine, UCSB, UPenn, UTA



# Light Readout (131.02.03.02.05)



## LCM Modules

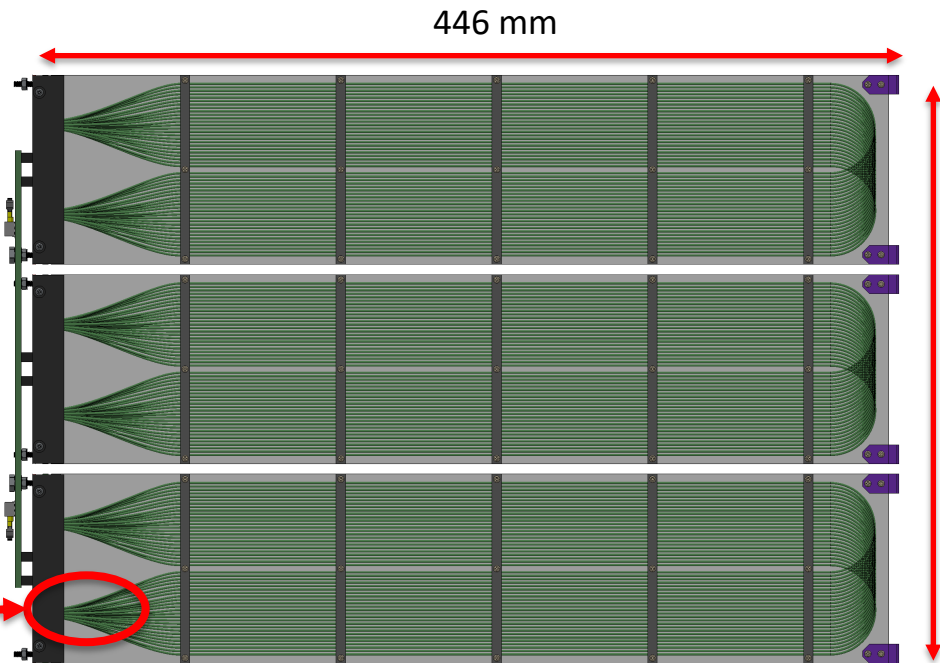
Shifts UV light (128 nm) into visible light (510nm)

- TPB on fibers shift 128 nm to 425 nm -> wavelength shifting fibers shift 425 nm to 510 nm -> Silicon Photomultipliers (SiPMs) detect 510 nm light
- Easy to scale -> fibers have long attenuation
- High detection efficiency, PDE ~ 1-2 %

One SiPM PCB per LCM

- Three LCMs per LRO array
- Six SiPMs per LCM array

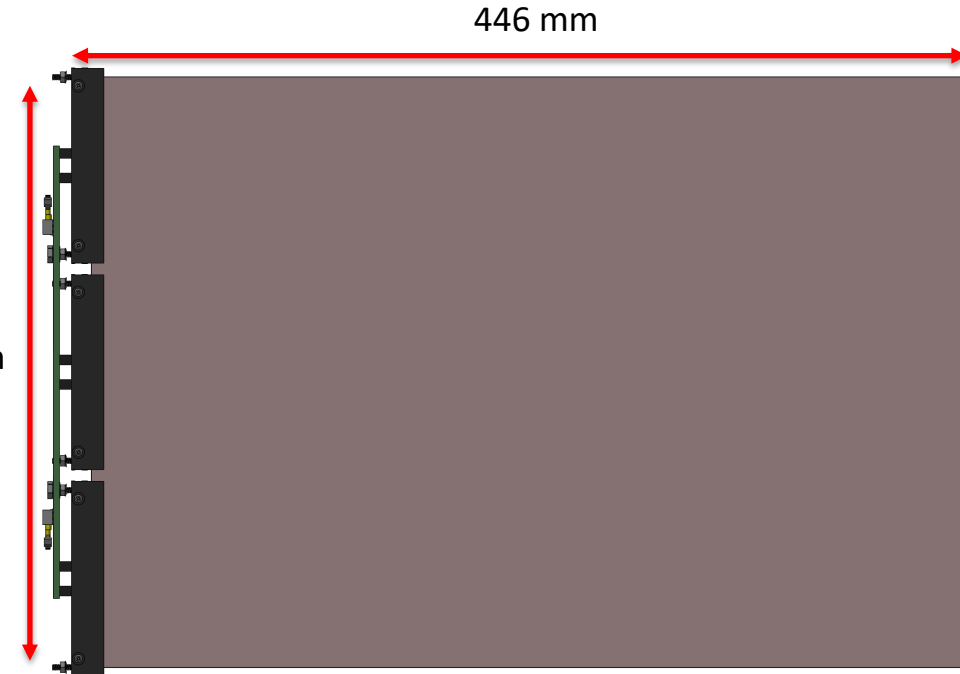
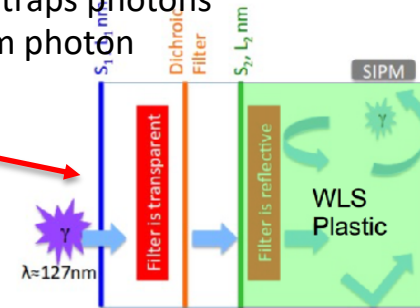
Bundle goes to SiPM



## ArCLight Modules

Shifts UV light (128 nm) into visible light (425nm)

- Wavelength shifting plastic (WLS) traps photons that pass through filters -> random photon movement until capture in Silicon Photomultipliers (SiPMs)
- Rigid construction
- Good spatial resolution



Institutions: JINR, Univ. of Bern

# Calibration (131.02.03.02.06)

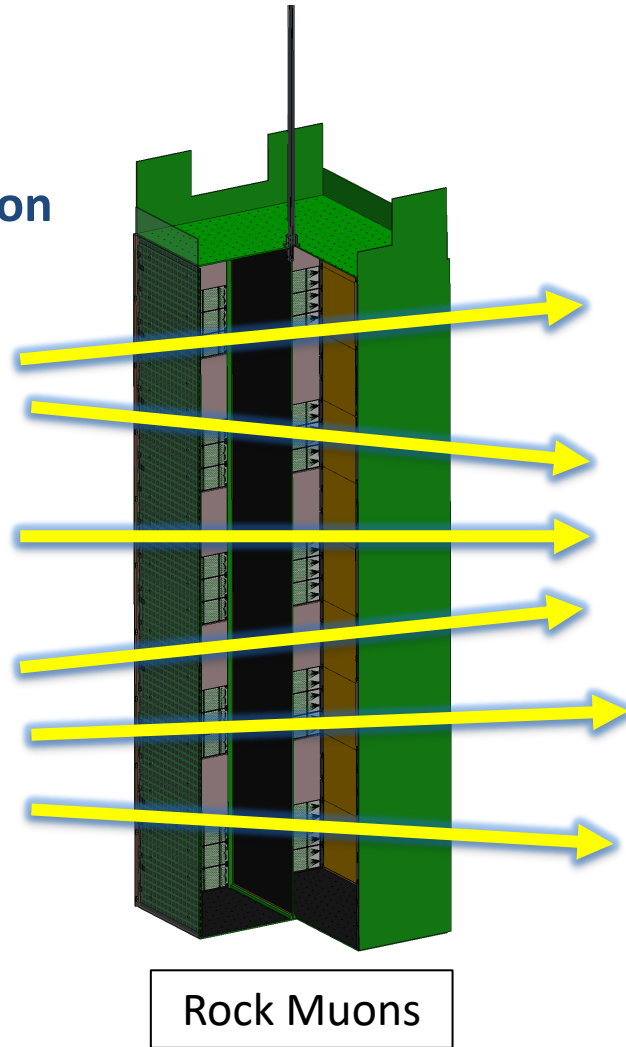
## Charge and Field Calibration

### Rock Muons

- Plentiful source in Near Site

### Ionization sources:

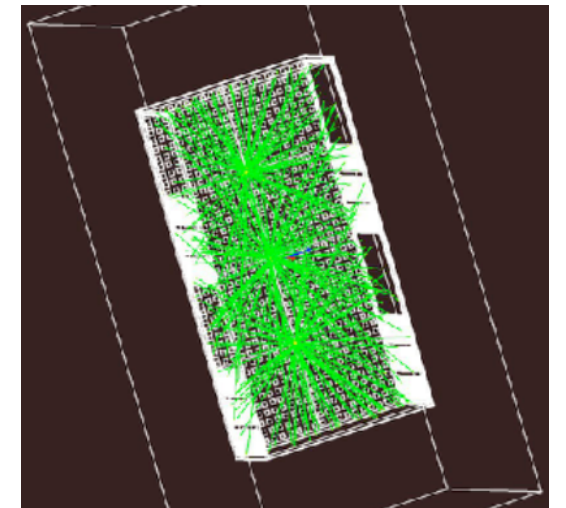
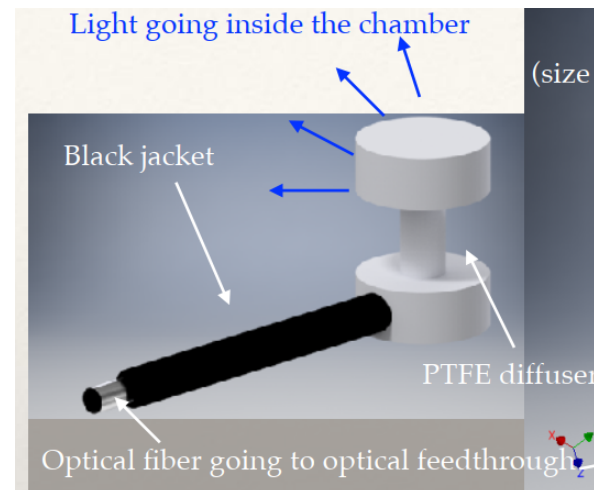
- Exploring potential, based on FD studies



## Light Calibration

### UV pulsers with diffusers

- Light input via optical fiber that is routed to warm feedthrough
- Location TBD based on simulation



Institutions: JINR, MSU, UH

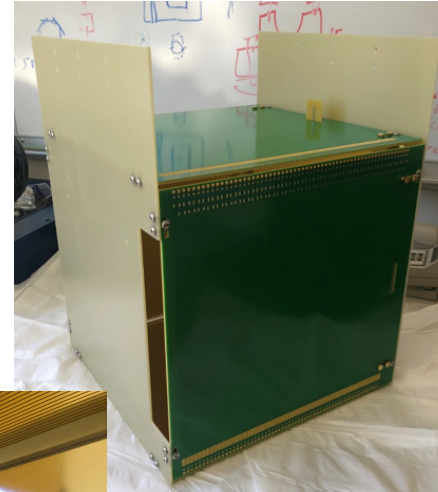
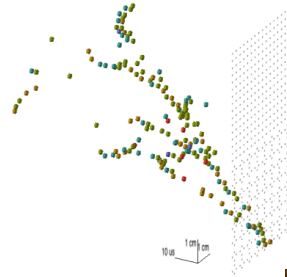
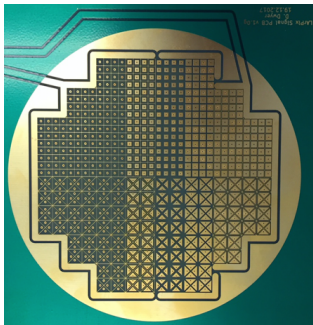
# ND LArTPC Prototyping / ArgonCube 2x2 Demonstrator

## Technology Prototypes (2016-2018)

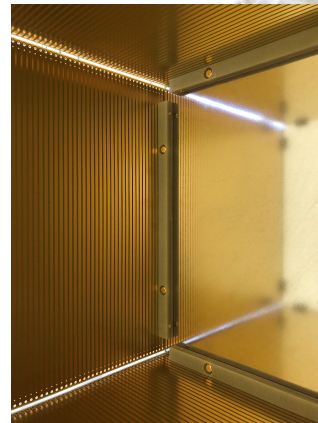
### Advanced Light Readout



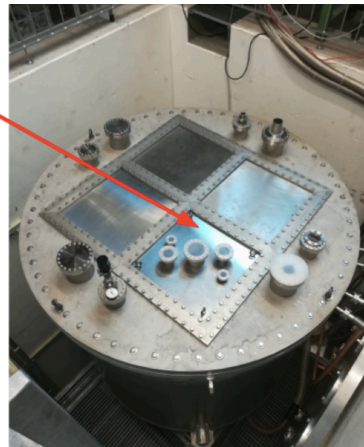
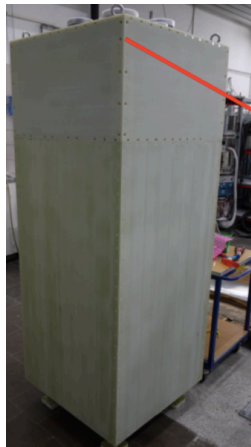
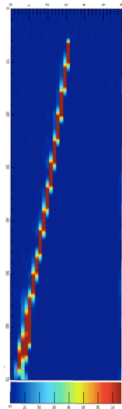
### Pixel Charge Readout



### Modular TPC Design

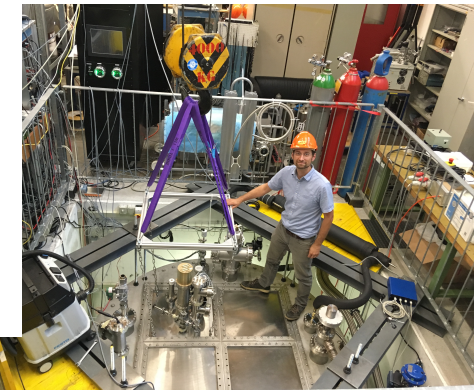


### Resistive Field Cage



## Near Detector Prototype (2019-2021)

1. *SingleCube*: Small-scale test of ArgonCube design
2. *Module 0*: First 2x2-scale detector module test
3. *ArgonCube 2x2 Demonstrator*
- 4 LArTPC modules, 3-tons active volume



## Adapting to COVID-19: SingleCube

### COVID-19:

- Delays in production of 2x2 components
- Travel restrictions to 2x2 site @ Bern

### Strategy response:

- Minor adjustment of LBNL pixel tile test TPC enables distributed 2x2 prototyping

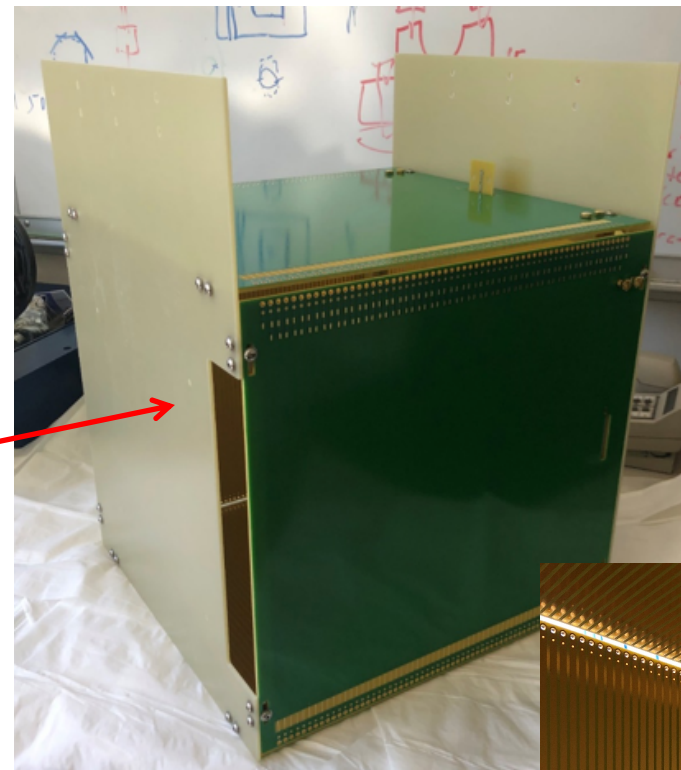
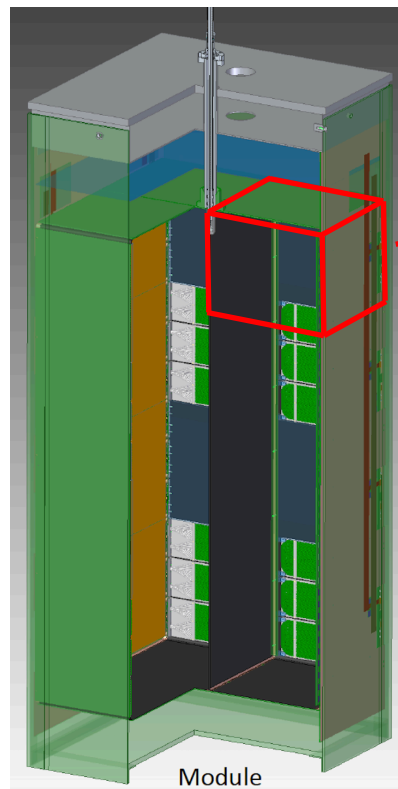
### SingleCube TPC:

- Scaled 2x2 design to smallest 'quanta': 1/16th
- Supports single 2x2 Pixel Tile and Light Module
- Same drift distance as 2x2
- Same materials and fixtures as 2x2

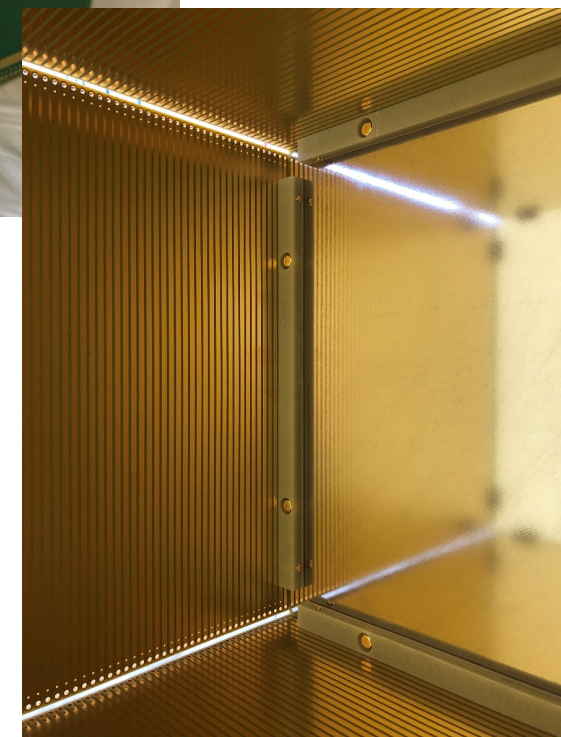
### Status:

- Produced all parts commercially during lab/university shutdowns
- Distributed SingleCube TPC kits to partners: Bern, CSU, UTA, SLAC
- Issue: delays in production of multiple charge & light readout systems

→ Enable more "shots-on-goal" for prototyping effort during COVID-19 pandemic



SingleCube TPC assembly @ LBNL



Interior view of SingleCube TPC

# ND LArTPC: From Prototyping to Production to Installation

**2019-2021**  
**ArgonCube 2x2**  
**Demonstrator**  
**'ProtoDUNE-ND'**



**2021-2023**  
**Full-scale ND**  
**Demonstrator**

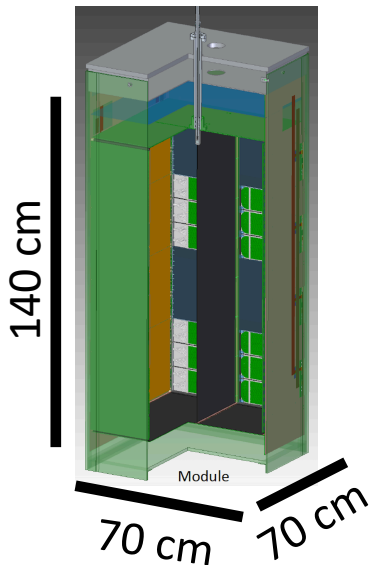


**2024-2026**  
**Production**

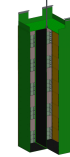
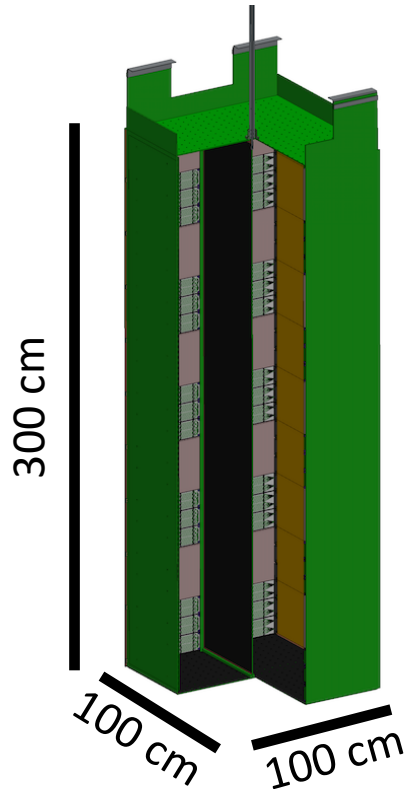


**2027-2029**  
**Installation**

SingleCube,  
 then 1 module (Module 0),  
 then 4 modules (2x2)  
 Operated in cryostat at Bern,  
 then FNAL in NuMI beam



1 Full-scale ND module  
 Operated in single-module cryostat



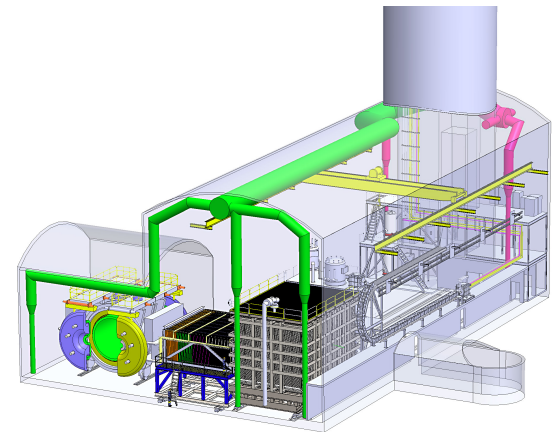
1 production  
 'first article'

35 (+5) Production modules  
 Each fully tested in single-module cryostat



**Deliverable:** modules packed and  
 ready for installation underground

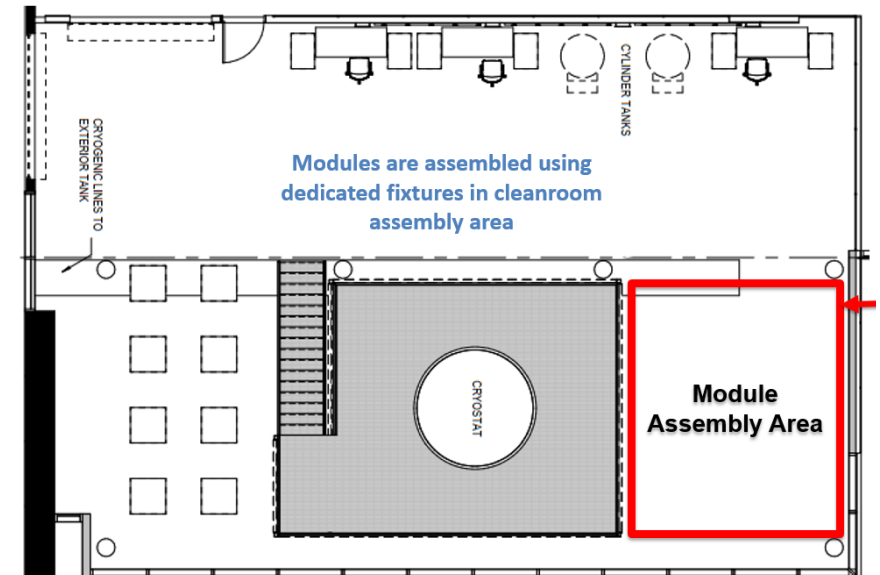
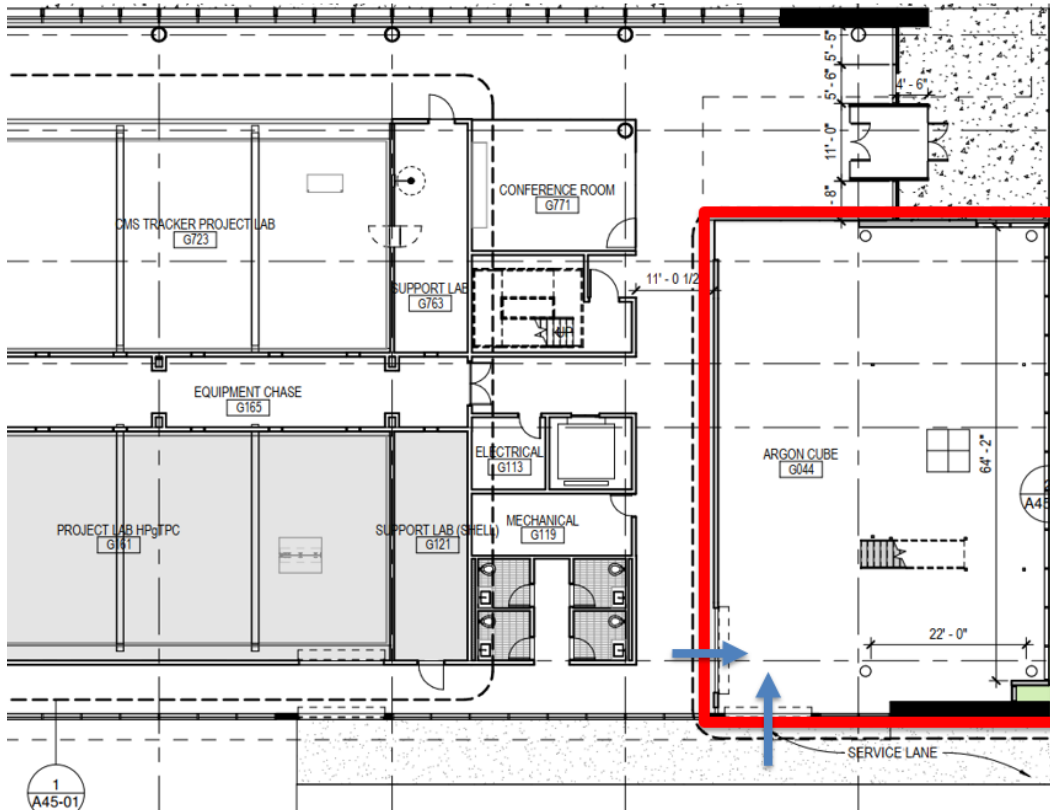
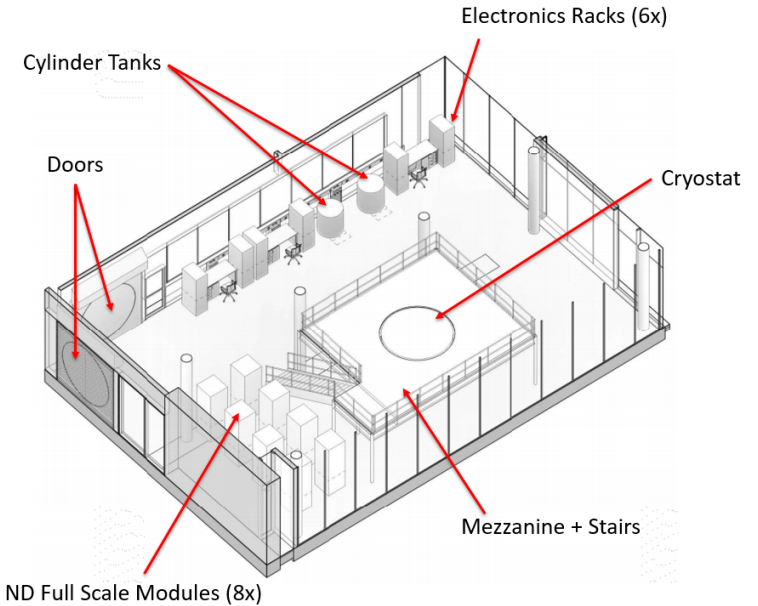
Support of TPC module  
 installation in Near Site  
 Activity driven by Near  
 Site Integration (NSI)



# Module Integration Facility @ IERC

- ✓ High-bay sufficient for ~4m-tall module assembly
- ✓ **Cryostat(s) capable of hosting ~4m x 1m x 1m module**
- ✓ Crane with ~4m clearance above cryostat for module installation/removal
- ✓ **System for LAr purification, recirculation, and cooling**
- ✓ **Cleanroom for module assembly**

- Specs
  - 3167 ft<sup>2</sup>
  - 12' X 12' Door Size
  - Temperature = 74°F +/- 2°F
  - Rel. Humidity = 50% +/- 10%
  - O<sub>2</sub> sensors
  - Vent for ODH purge
  - Sprinkler system
  - Power & ground @ walls every 11'
  - Data outlets @ walls every 11'
  - 25-ton gantry crane w/hook @ 25' (7.62 meters)
- Services:
  - CDA
  - Vacuum
  - Nitrogen
  - Other: Local use Ar, LAr, LN2



Institutions: All



# Major Design Concerns

## Identify and address any outstanding concerns with the existing design

### Goal:

Rapidly address any major design concerns before we progress too far into the preliminary design

### Today:

Requesting input from full Consortium. Please review/enter in the shared spreadsheet by next Thursday (Sep. 10):

[https://docs.google.com/spreadsheets/d/11L\\_INb8Jsgv6g3gW8x4JVjG3Mgt7q3aMzV4E1kbZpks](https://docs.google.com/spreadsheets/d/11L_INb8Jsgv6g3gW8x4JVjG3Mgt7q3aMzV4E1kbZpks)

### In 1 Week:

Discuss with the team of subsystem leads, and propose a plan for addressing each item.

### In 4 Weeks:

Report status to the full Consortium.

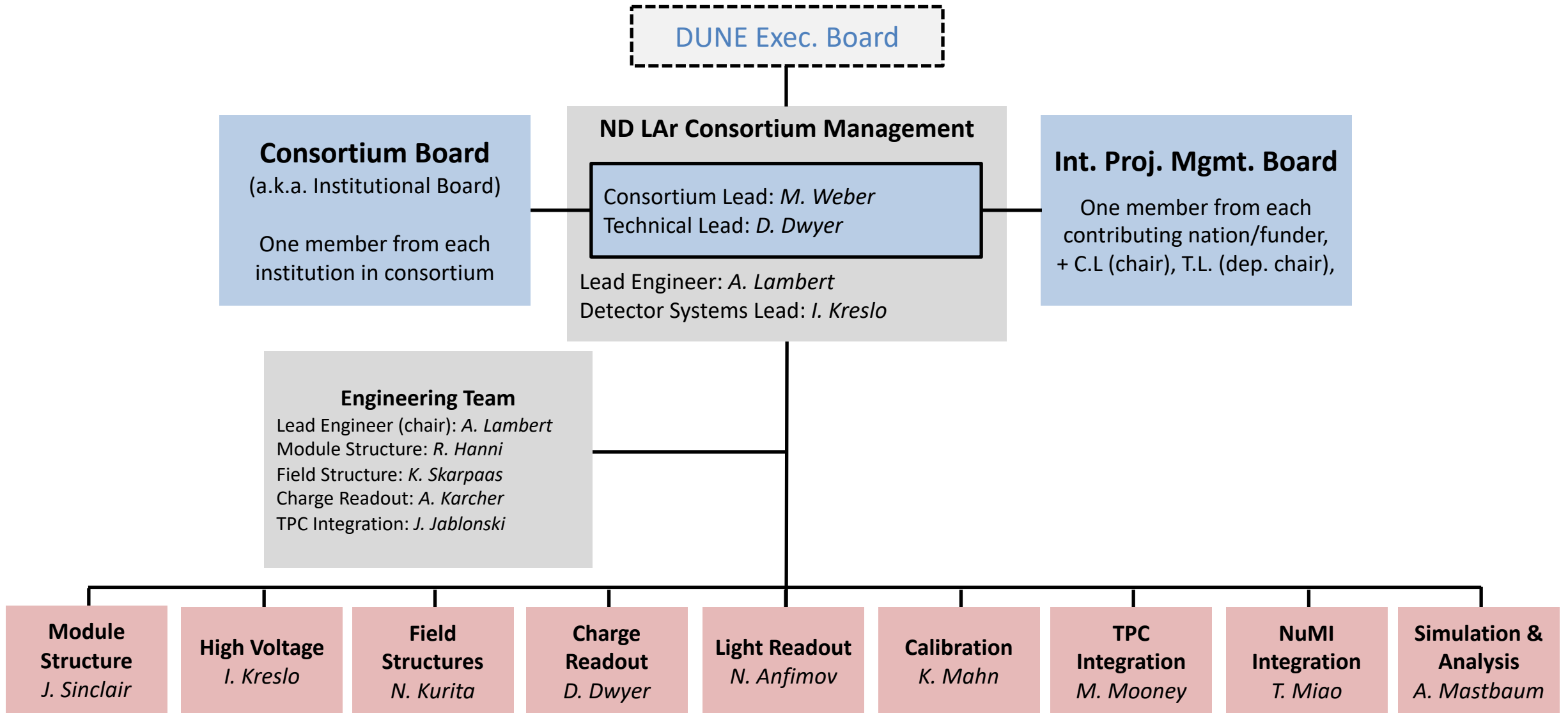


## Summary

- Substantial work for our Consortium to perform, both near-term and long-term
- Many potential roles for new partners
- Activities in need of near-term help:
  - Simulation studies to help inform preliminary design
  - Analysis of prototype data to understand system performance, unexpected issues

# Backup

# Organization: ND-LAr (ArgonCube) Consortium



# Interfaces

- DUNE Near Detector Consortia
  - International bodies responsible for delivering detector systems
- ND LArTPC Cryostat
  - Multiple interfaces: Mechanical, electrical, cryo, etc.
  - Cryostat engineer is also Consortium Lead Engineer (A. Lambert)
- LBNF Cryogenics
  - Provides LAr cryogenic system for ND LArTPC
- Near Site Integration
  - Manages interface between Near Detector and NSCF
  - Installation of Near Detector System
    - NSI provides coordination: installation engineer, general technician team
    - ND provides support: scientific labor and technical experts

ND Interface Matrix *A. Lambert*

	LArTPC Cryostat	LArTPC	DAQ	LBNF	NSI&I	MPD	PRISM	SAND
LArTPC Cryostat		1	1	1 2	1	1	1	1
LArTPC	3		1	1 2	3		3	
DAQ	1	1		4	1			
LBNF	1	2	1	2		1	2	
NSI&I	3	3						
NSI&I	1		1	1 2		1	1	1
MPD	1				1			
PRISM	1				1			
SAND	1				1			